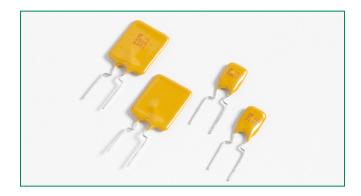
POLY-FUSE® Resettable PTCs

Radial Leaded > 16R Series

16R Series





Agency Approvals

AGENCY	AGENCY FILE NUMBER				
c 'FLL ' us	E183209				
A	R50119318				

Description

Littelfuse 16R Series Radial Leaded PTCs are designed to provide resettable overcurrent protection serving a wide range of electronics applications. With maximum 16 volts and maximum 100-ampere short circuit rating, they offer an ideal solution for USB protection.

Features

- 100A short circuit rating
- 16V Operating voltages
- Fast time-to-trip
- Meets all USB protection requirements
- RoHS compliant, Lead-Free and Halogen-Free*

Applications

- Computers & peripherals
- Any USB application
- General Electronics

Additional Information







Resources



Sample

Electrical Characteristics

Part Number	l bold	 hold	l bold	l bold	l bold	 bold	 bold	 bold	l trip	V _{max}	l _{max}	P _d	-	ım Time Trip	Resis	tance	Age Appr	ncy ovals
Part Number	(A)	(Å)	(Vdc)	(A)		Current (A)	Time (Sec.)	R _{min} (Ω)	R _{1max} (Ω)	c 712 us	A							
16R250G	2.5	4.7	16	100	1.0	12.5	5.0	0.0220	0.0530	Х	Χ							
16R300G	3.0	5.1	16	100	2.3	15.0	1.0	0.0380	0.0975	Х	Х							
16R400G	4.0	6.8	16	100	2.4	20.0	1.7	0.0210	0.0600	Х	Х							
16R500G	5.0	8.5	16	100	2.6	25.0	2.0	0.0150	0.0340	Х	Х							
16R600G	6.0	10.2	16	100	2.8	30.0	3.3	0.0100	0.0280	Х	Χ							
16R700G	7.0	11.9	16	100	3.0	35.0	3.5	0.0077	0.0200	Х	Χ							
16R800G	8.0	13.6	16	100	3.0	40.0	5.0	0.0056	0.0175	Х	Χ							
16R900G	9.0	15.3	16	100	3.3	45.0	5.5	0.0047	0.0135	Х	Χ							
16R1000G	10.0	17.0	16	100	3.6	50.0	6.0	0.0040	0.0102	Х	Χ							
16R1100G	11.0	18.7	16	100	3.7	55.0	7.0	0.0037	0.0089	Х	Х							
16R1200G	12.0	20.4	16	100	4.2	60.0	7.5	0.0033	0.0086	Х	Х							
16R1400G	14.0	23.8	16	100	4.6	70.0	9.0	0.0026	0.0064	Х	Х							

I $_{\mathrm{hold}}$ = Hold current: maximum current device will pass without tripping in 20°C still air.

Caution: Operation beyond the specified rating may result in damage and possible arcing and flame.

 $I_{\rm trip}$ = Trip current: minimum current at which the device will trip in 20°C still air.

V max = Maximum voltage device can withstand without damage at rated current (I max)

 I_{max} = Maximum fault current device can withstand without damage at rated voltage (V_{max})

 $P_{\rm d}$ = Power dissipated from device when in the tripped state at 20°C still air.

 R_{min} = Minimum resistance of device in initial (un-soldered) state.

R _{1max} = Maximum resistance of device at 20°C measured one hour after tripping.

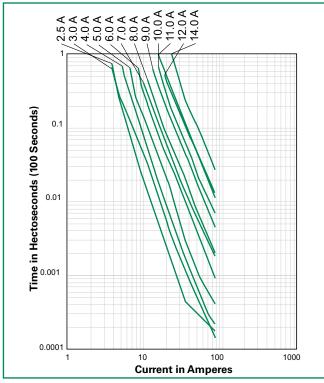
^{*} Effective January 1, 2010, all 16R PTC products will be manufactured Halogen Free (HF). Existing Non-Halogen Free 16R PTC products may continue to be sold, until supplies are depleted.



Temperature Rerating

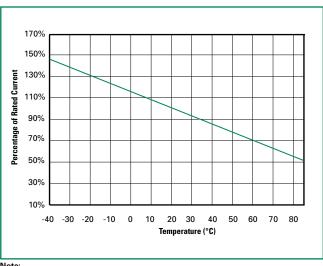
Ambient Operation Temperature												
	-40°C	-20°C	0°C	20°C	40°C	50°C	60°C	70°C	85°C			
Part Number	Hold Current (A)											
16R250G	3.7	3.3	2.9	2.5	2.2	2.0	1.8	1.6	1.3			
16R300G	4.4	4.0	3.5	3.0	2.6	2.4	2.1	1.9	1.6			
16R400G	5.9	5.3	4.7	4.0	3.5	3.2	2.9	2.6	2.1			
16R500G	7.4	6.6	5.9	5.0	4.4	4.0	3.6	3.2	2.6			
16R600G	8.9	8.0	7.1	6.0	5.2	4.8	4.3	3.9	3.2			
16R700G	10.4	9.3	8.2	7.0	6.1	5.6	5.0	4.5	3.7			
16R800G	11.8	10.6	9.4	8.0	7.0	6.3	5.7	5.1	4.2			
16R900G	13.3	12.0	10.6	9.0	7.8	7.1	6.5	5.8	4.7			
16R1000G	14.8	13.3	11.8	10.0	8.7	7.9	7.1	6.4	5.3			
16R1100G	16.3	14.6	12.9	11.0	9.6	8.7	7.9	7.0	5.8			
16R1200G	17.7	15.9	14.1	12.0	10.5	9.5	8.6	7.7	6.3			
16R1400G	20.7	18.6	16.5	14.0	12.2	11.1	10.0	9.0	7.4			

Average Time Current Curves



The average time current curves and Temperature Rerating curve performance is affected by a number or variables, and these curves provided as guidance only. Customer must verify the performance in their application.

Temperature Rerating Curve



Note:

Typical Temperature rerating curve, refer to table for derating data

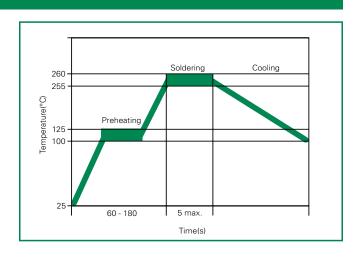
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Radial Leaded > 16R Series

Soldering Parameters - Wave Soldering

Due Heating Zone	Refer to the condition recommended by the flux manufacturer.
Pre-Heating Zone	Max. ramping rate should not exceed 4°C/Sec.
Soldering Zone	Max. solder temperature should not exceed 260°C
	Time within 5°C of actual Max. solder temperature within 3 – 5 seconds
	Total time from 25°C room to Max. solder temperature within 5 minutes including Pre-Heating time
	Cooling by natural convection in air.
Cooling Zone	Max. ramping down rate should not exceed 6°C/Sec.



Physical Specifications

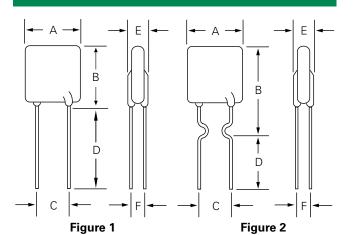
Lead Material	2.5A: Tin-plated Copper clad Steel				
Leau Materiai	3.0 - 14.0A: Tin-plated Copper				
Soldering Characteristics	Solderability per MIL-STD-202, Method 208				
Insulating Material	Cured, flame retardant epoxy polymer meets UL 94V-0 requirements.				
Device Labeling	Marked with 'LF', voltage, current rating, and date code.				

Environmental Specifications

Operating/Storage Temperature	-40°C to +85°C
Maximum Device Surface Temperature in Tripped State	125°C
Passive Aging	+85°C, 1000 hours -/+ 5% typical resistance change
Humidity Aging	+85°C, 85% R.H., 1000 hours -/+ 5% typical resistance change
Thermal Shock	+85°C to -40°C 10 times -/+ 5% typical resistance change
Solvent Resistance	MIL-STD-202, Method 215 No change
Moisture Resistance Level	Level 1, J-STD-020

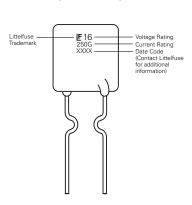


Dimensions



Part Marking System

Single Sided Marking



	_ A		В		С		D		Е		F		Physical Chara		acteristics	
	Ŭ	Inches	mm	Inches	mm	Inches	mm	Inches	mm	Inches	mm	Inches	mm	Lead (dia)	Material
Number	10	Max.	Max.	Max.	Max.	Тур.	Тур.	Min.	Min.	Max.	Max.	Тур.	Тур.	Inches	mm	iviateriai
16R250G	2	0.35	8.90	0.50	12.80	0.20	5.1	0.13	3.18	0.12	3.00	0.035	0.9	0.020	0.51	Sn/ CuFe
16R300G	1	0.28	7.10	0.43	11.00	0.20	5.1	0.30	7.6	0.12	3.00	0.047	1.2	0.032	0.81	Sn/Cu
16R400G	1	0.35	8.90	0.50	12.80	0.20	5.1	0.30	7.6	0.12	3.00	0.047	1.2	0.032	0.81	Sn/Cu
16R500G	1	0.41	10.40	0.56	14.30	0.20	5.1	0.30	7.6	0.12	3.00	0.047	1.2	0.032	0.81	Sn/Cu
16R600G	1	0.42	10.70	0.67	17.10	0.20	5.1	0.30	7.6	0.12	3.00	0.047	1.2	0.032	0.81	Sn/Cu
16R700G	1	0.44	11.20	0.78	19.70	0.20	5.1	0.30	7.6	0.12	3.00	0.047	1.2	0.032	0.81	Sn/Cu
16R700G KL	2	0.44	11.20	0.93	23.70	0.20	5.1	0.30	7.6	0.12	3.00	0.047	1.2	0.032	0.81	Sn/Cu
16R800G	1	0.50	12.70	0.82	20.90	0.20	5.1	0.30	7.6	0.12	3.00	0.047	1.2	0.032	0.81	Sn/Cu
16R900G	1	0.55	14.00	0.85	21.70	0.20	5.1	0.30	7.6	0.12	3.00	0.047	1.2	0.032	0.81	Sn/Cu
16R1000G	1	0.65	16.50	0.99	25.20	0.20	5.1	0.30	7.6	0.12	3.00	0.047	1.2	0.032	0.81	Sn/Cu
16R1100G	1	0.69	17.50	1.02	26.00	0.20	5.1	0.30	7.6	0.12	3.00	0.047	1.2	0.032	0.81	Sn/Cu
16R1200G	1	0.69	17.50	1.10	28.00	0.40	10.2	0.30	7.6	0.14	3.50	0.055	1.4	0.039	1.00	Sn/Cu
16R1400G	1	0.93	23.50	1.10	27.90	0.40	10.2	0.30	7.6	0.14	3.50	0.055	1.4	0.039	1.00	Sn/Cu

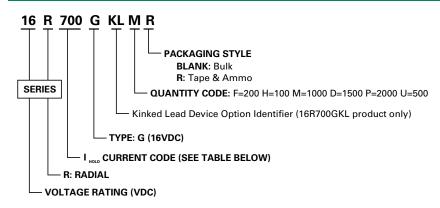
WARNING

- Users shall independently assess the suitability of these devices for each of their applications
- Operation of these devices beyond the stated maximum ratings could result in damage to the devices and lead to electrical arcing and/or fire
- These devices are intended to protect against the effects of temporary over-current or over-temperature conditions and are not intended to perform as protective devices where such conditions are expected to be repetitive or prolonged in duration
- Exposure to silicon-based oils, solvents, electrolytes, acids, and similar materials can adversely affect the performance of these PPTC devices
- These devices undergo thermal expansion under fault conditions, and thus shall be provided with adequate space and be protected against mechanical stresses
- Circuits with inductance may generate a voltage (L di/dt) above the rated voltage of the PPTC device.



Radial Leaded > 16R Series

Part Ordering Number System



Packaging Options

Part Number	Ordering Number	I _{hold} (A)	I _{hold} Code	Packaging Option	Quantity	Quantity & Packaging Codes	
16D2E0C	16R250GU	2.50	250	Bulk	500	U	
16R250G	16R250GPR	2.50	250	Tape and Ammo	2000	PR	
16R300G	16R300GU	3.00	300	Bulk	500	U	
	16R300GPR	3.00	300	Tape and Ammo	2000	PR	
16R400G	16R400GU	4.00	400	Bulk	500	U	
1004000	16R400GPR	4.00	400	Tape and Ammo	2000	PR	
16R500G	16R500GU	5.00	500	Bulk	500	U	
	16R500GPR	5.00	500	Tape and Ammo	2000	PR	
16R600G	16R600GU	6.00	600	Bulk	500	U	
Tohoud	16R600GDR	0.00	600	Tape and Ammo	1500	DR	
	16R700GF		700	Bulk	200	F	
16R700G	16R700GKLF	7.00		Duik	200	'	
1017000	16R700GMR	7.00		Tape and Ammo	1000	MR	
	16R700GKLMR			Tape and Amino	1000	IVIN	
16R800G	16R800GF	8.00	800	Bulk	200	F	
TOHOUUG	16R800GMR	0.00	000	Tape and Ammo	1000	MR	
16R900G	16R900GF	9.00	900	Bulk	200	F	
10113000	16R900GMR	9.00	300	Tape and Ammo	1000	MR	
16R1000G	16R1000GF	10.00	1000	Bulk	200	F	
10010000	16R1000GMR	10.00	1000	Tape and Ammo	1000	MR	
16R1100G	16R1100GF	11.00	1100	Bulk	200	F	
IONTIOUG	16R1100GMR	11.00	1100	Tape and Ammo	1000	MR	
16R1200G	16R1200GH	12.00	1200	Bulk	100	Н	
IDN 1200G	16R1200GMR	12.00	1200	Tape and Ammo	1000	MR	
16R1400G	16R1400GH	14.00	1400	Bulk	100	Н	

Disclaimer Notice - Information furnished is believed to be accurate and reliable. However, users should independently evaluate the suitability of and test each product selected for their own applications. Littelfuse products are not designed for, and may not be used in, all applications. Read complete Disclaimer Notice at www.littelfuse.com/disclaimer-electronics.

Devices taped using EIA468-B/IE286-2 standards. See table below and Figure 1 for details.



Dimensions

20 consecutive

0.9

2.0

0

0

0

3.81

7.62

5.08

10.18

-/+ 1

max.

max.

-/+ 0.3

-/+ 1.0

-/+ 1.3

-/+0.7

-/+ 0.7

-/+ 0.8

-/+ 0.8

Tape and Ammo Specifications

EIA Mark IEC Mark Dim. (mm) Tol. (mm) W W 18 Carrier tape width -0.5 /+1.0Hold down tape width: W_{o} W, 11 min. W_6 Top distance between tape edges W, max. W, W, 9 -0.5 /+0.75 Sprocket hole position Sprocket hole diameter* D_o D_o 4 -0.32 /+0.2 Abscissa to plane(straight lead) Н -/+ 3.0 Н 18.5 Abscissa to plane(kinked lead) H_o H_o 16 -/+ 0.5 Abscissa to top 45.0 max. Overall width w/o lead protrusion 56 max. Overall width w/ lead protrusion 57 max. Lead protrusion 1.0 L, I, max. Protrusion of cut out L L 11 max. Protrusion beyond hold-down tape l₂ l₂ Not specified Sprocket hole pitch P_0 P_0 25.4 -/+ 0.5 Device pitch: 25.4

t

Δh

Δр

F

t

t,

Δh

Δр

 P_1

F

Tape and Ammo Diagram

Pitch tolerance

Tape thickness

Tape thickness with splice

Splice sprocket hole alignment

Body lateral deviation

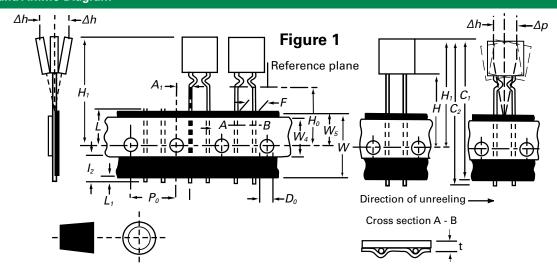
Body tape plane deviation

Ordinate to adjacent component lead*

Ordinate to adjacent component lead*

Lead spacing:16R250G-16R1100G

Lead spacing:16R1200G-16R1400G



^{*}Differs from EIA specification